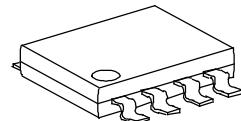


Low-Noise Step-Up Current Mode PWM IC**GENERAL DESCRIPTION**

The **FP6290** is a boost converter of current mode , PWM circuitry with a built-in 0.2Ω power MOSFET provides a highly efficient regulator. Selectable high switching frequency allows easy filtering, faster loop performance in a low noise output. The non-inverting input of error amplifier connects to a 1.24V precision reference voltage. Soft-Start is programmed with an external capacitor, which sets the input current ramp rate. Current mode control and external compensation network make it easy and flexible to stabilize the system. The **FP6290** is available in the MSOP-8L package, using of low ESR capacitors and reduced PCB space for the step-up application fields.

FEATURES

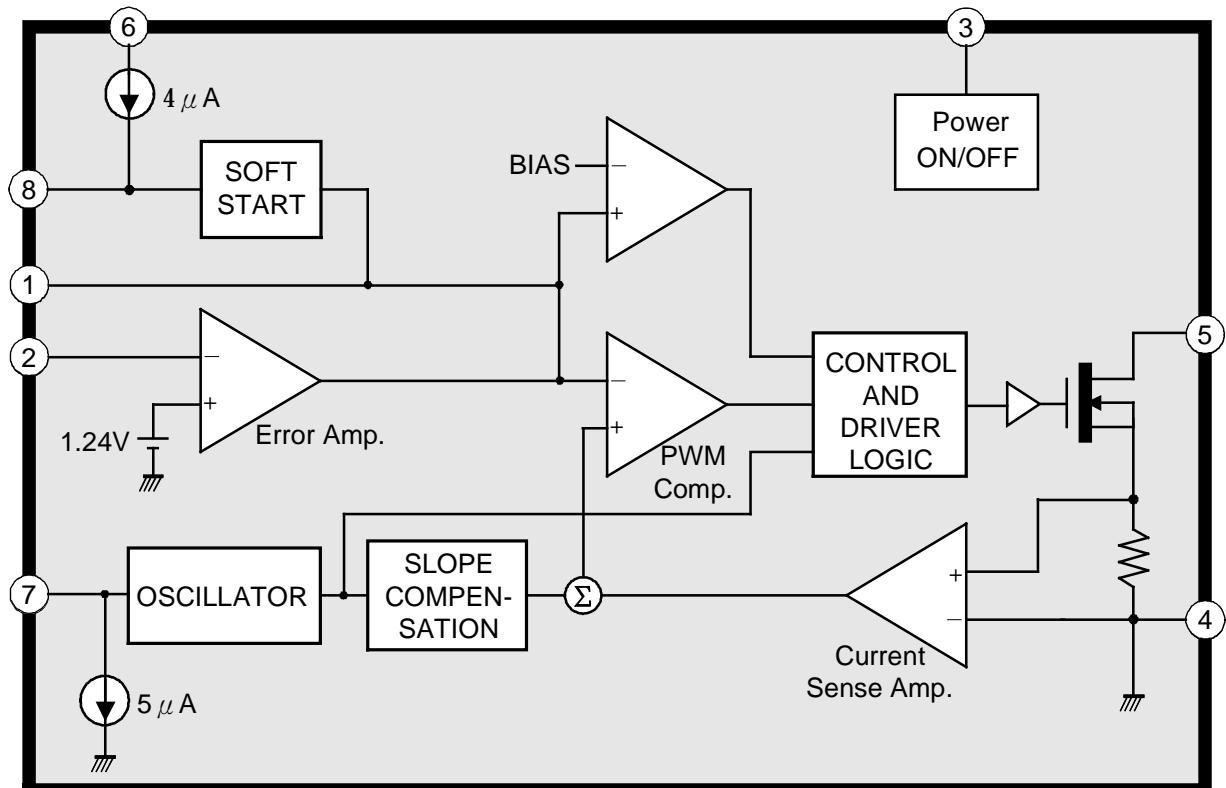
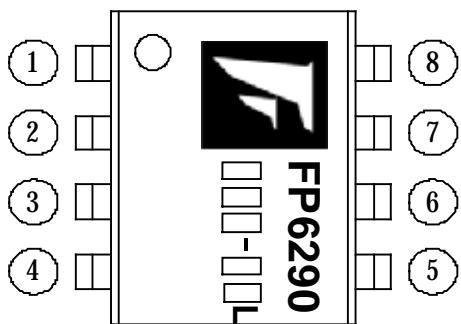
- Precision feedback reference voltage: 1.24V
- Current Limit Protection
- Internal fixed PWM frequency
- Pin control frequency: 640KHz/1.2MHz
- External Programmable Soft-Start function (SS)
- Internal 0.2Ω , 1.6A, 14V Power MOSFET
- Shutdown Current : 0.1uA
- Adjustable Output from VCC to 12V
- Package: MSOP8



MSOP8

TYPICAL APPLICATION

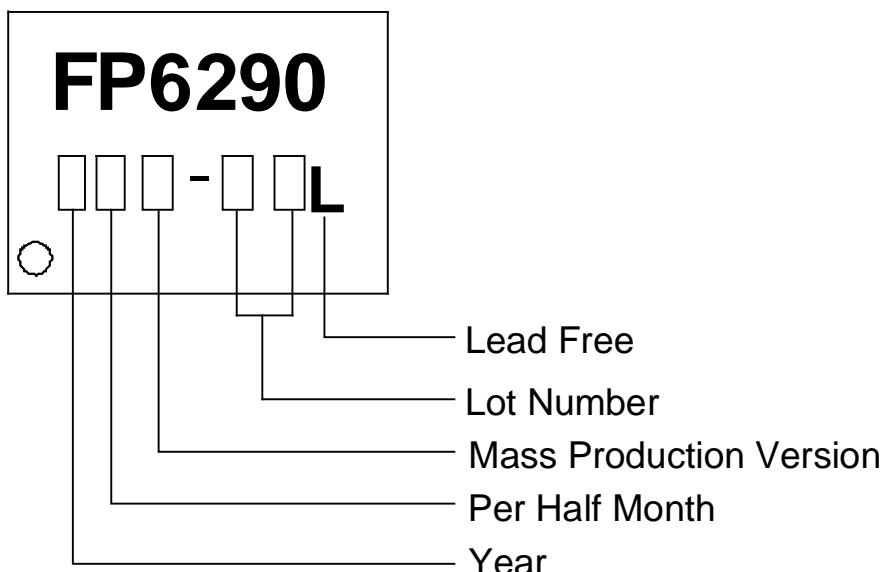
- LCD Display
- Digital Camera
- Hand-Held Device
- Portable product

FUNCTIONAL BLOCK DIAGRAM

MARK VIEW

PIN DESCRIPTION

NAME	NO.	STATUS	DESCRIPTION
COMP	1	O	Error Amplifier Compensation Output
FB	2	I	Error Amplifier Inverting Input
EN	3	I	Enable Control
GND	4	P	IC Ground
LX	5	O	Switch Output
VCC	6	P	IC Power Supply
FREQ	7	O	Frequency Selection
SS	8	I	Soft-start Control

ORDER INFORMATION

Part Number	Operating Temperature	Package	Description
FP6290T-LF	-40°C ~ +85°C	MSOP8	Tube
FP6290TR-LF	-40°C ~ +85°C	MSOP8	Tape & Reel

IC DATE CODE DISTINGUISH

FOR EXAMPLE:

January	A (Front Half Month), B (Last Half Month)
February	C, D
March	E, F -----And so on

Lot Number is the last two numbers

For Example:

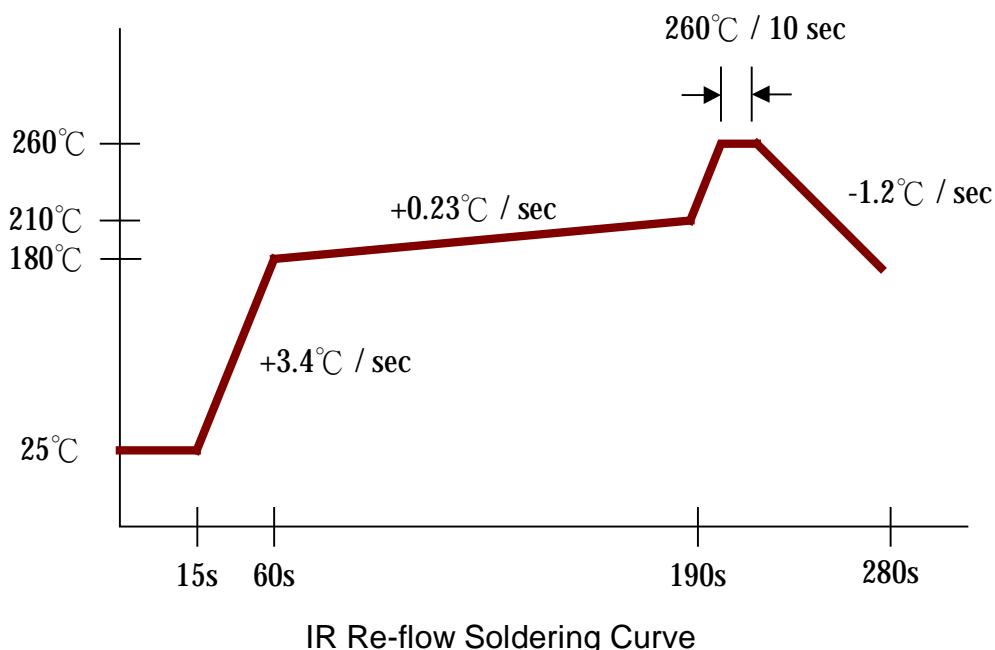
A3311C62

→ Lot Number

ABSOLUTE MAXIMUM RATINGS

Supply Voltage (VCC) -----	+6.0V
RMS LX Current -----	1.2A
LX to GND -----	-0.3V ~ +14V
SS,COMP to GND -----	-0.3V ~ VCC+0.3V
EN,FREQ,FB to GND -----	-0.3V ~ VCC
Allowable dissipation	
MSOP8 Ta \leq +70°C-----	330mW
Operating temperature-----	-40°C ~ +85°C
Storage temperature-----	-55°C ~ +125°C
MSOP8 Lead Temperature (soldering, 10 sec) -----	+260°C

Recommend: IR Reflow



DC ELECTRICAL CHARACTERISTICS

Electrical characteristics over recommended operating free-air temperature range, VCC=3V, FREQ=GND (unless otherwise noted)

Reference section

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Output voltage	V _{REF}	COMP connected to FB	1.222	1.240	1.258	V
Line regulation	△V _{REF} /V _{REF}	VCC=2.6V~5.5V		0.05		% / V
Output voltage change with Temperature		T _A =-40°C to 25°C		1		%
		T _A = 25°C to 85°C		1		

Under voltage lockout section

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Upper threshold voltage(Vcc)	V _{UPPER}	T _A =25°C		2.38	2.53	V
Lower threshold voltage(Vcc)	V _{LOW}			2.33	2.48	V
Hysteresis (Vcc)	V _{HYS}			50		mV

Soft-start section

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Reset switch Resistance	R _{SS}				100	Ω
Input source current	I _{SS}	V _{SS} =1.2V	1.5	4.0	7.0	μA

Oscillator section

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Frequency	f	FREQ=GND	540	640	740	KHz
		FREQ=VCC	1.00	1.22	1.50	MHz
Frequency change with voltage	△f/△V	VCC=2.6V to 5.5V		2		% / V
Frequency change with Temperature	△f/△T	T _A =-40°C to 85°C		10		%
Maximum duty cycle	T _{DUTY}	FREQ=GND	79	88		%
		FREQ=VCC		88		%

Error –amplifier section

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
FB Input bias current	I _{BIAS}	V _{FB} =1.24V			40	nA
Transconductance	gm	△I=5 μA	70	140	240	μA/V
Voltage Gain	Av			700		V/V

Output section

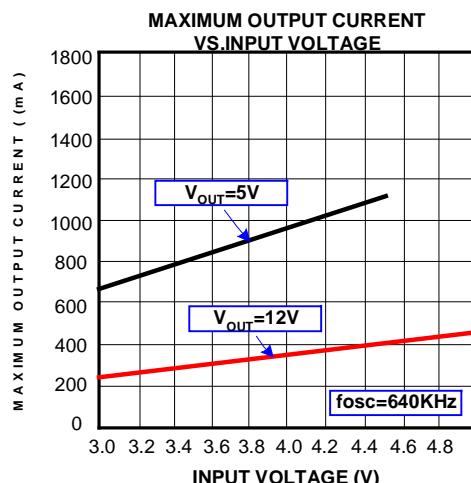
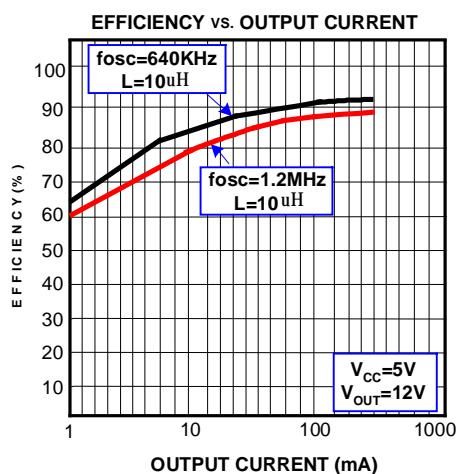
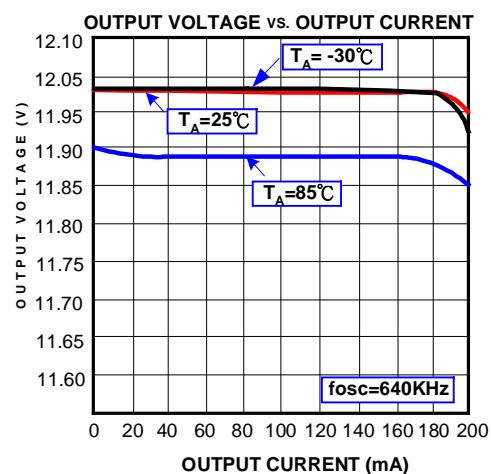
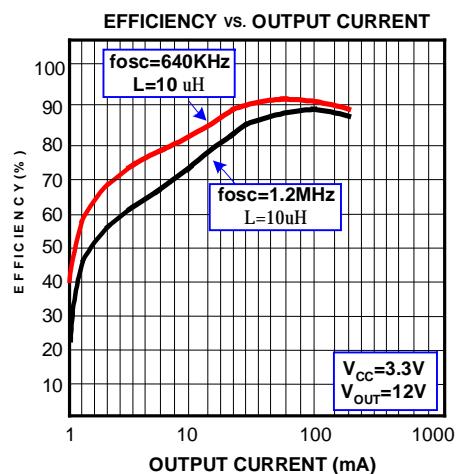
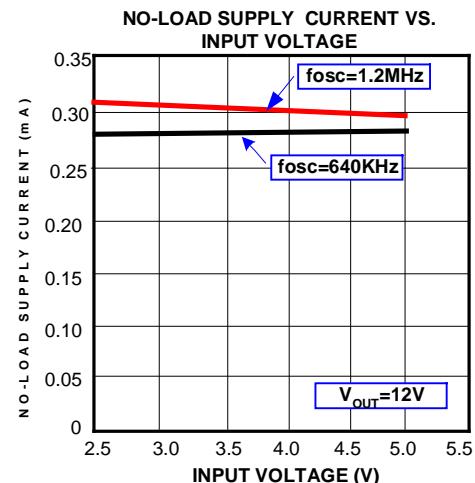
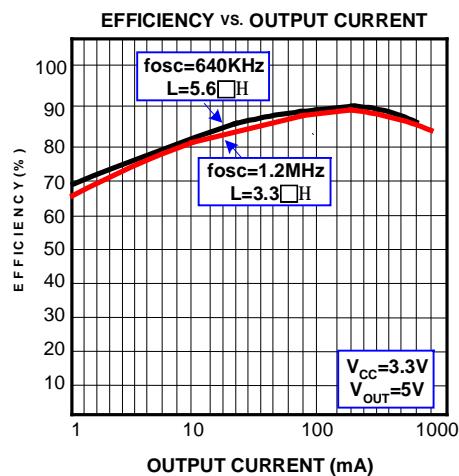
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
NMOS Current Limit	I _{LIM}	V _{FB} =1V,Duty Cycle=65%	1.2	1.6	2.3	A
NMOS On resistance	R _{DS(ON)}	I _{LX} =1.2A		0.2	0.5	Ω
Output leakage current	I _{LXOFF}	V _{LX} =12V		0.01	20	μA
Current-Sense Trans-resistance	R _{CS}			0.56		V/A

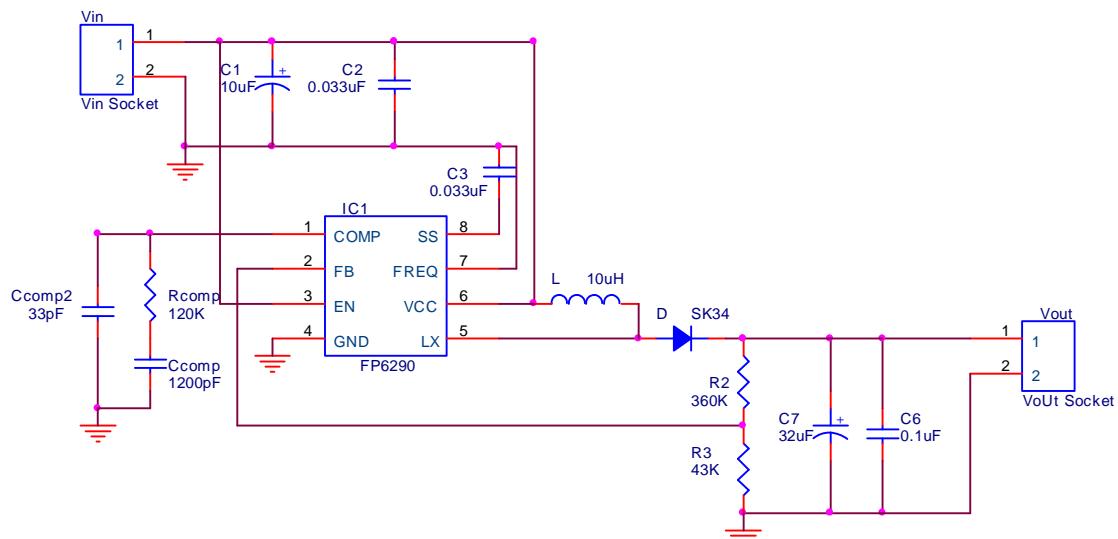
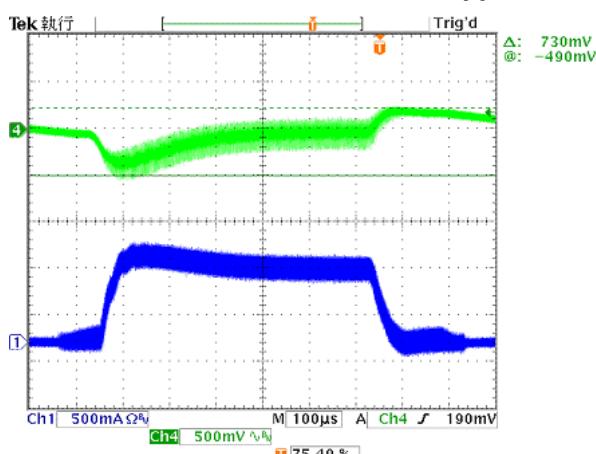
DC ELECTRICAL CHARACTERISTICS (Cont.)
Control Input section

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Input High Voltage	V_{IH}	EN,FREQ; $V_{CC}=2.6V\sim 5.5V$	$0.7 \times V_{CC}$			V
Input Low Voltage	V_{IL}	EN,FREQ; $V_{CC}=5.5V\sim 2.6V$			$0.3 \times V_{CC}$	V
Hysteresis		EN,FREQ		$0.1 \times V_{CC}$		V
FREQ Pull-Down Current	I_{FREQ}		1.8	5	9	μA
EN Input Current	I_{EN}			1		nA

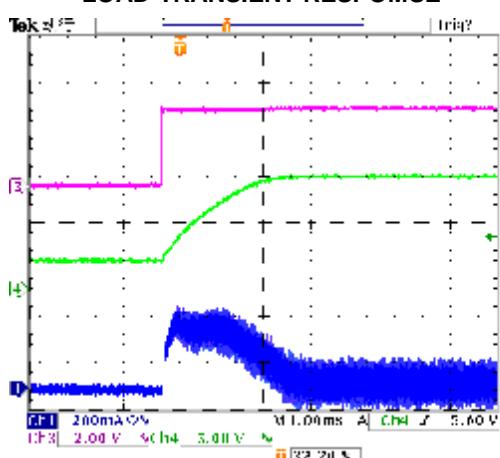
Total device

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Input Supply Range	V_{CC}		2.6		5.5	V
Disable Supply Current	$I_{Disable}$	EN=GND		0.1	10	μA
Standby Supply Current	I_{SBY}	$V_{FB}=1.3V$		0.20	0.35	mA
Average Supply Current	I_{AVG}	$V_{FB}=1.0V$		2.0	5.0	mA

TYPICAL CHARACTERISTICS


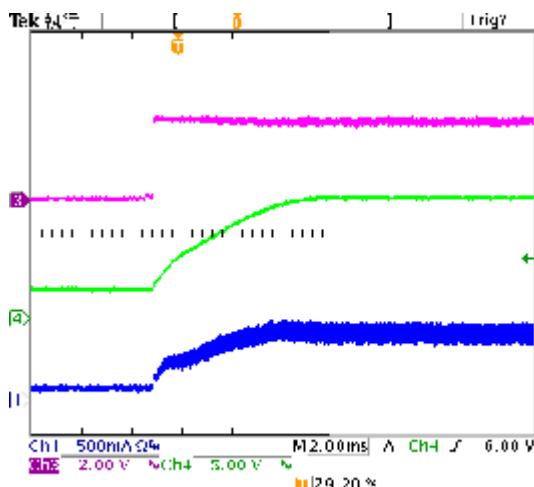
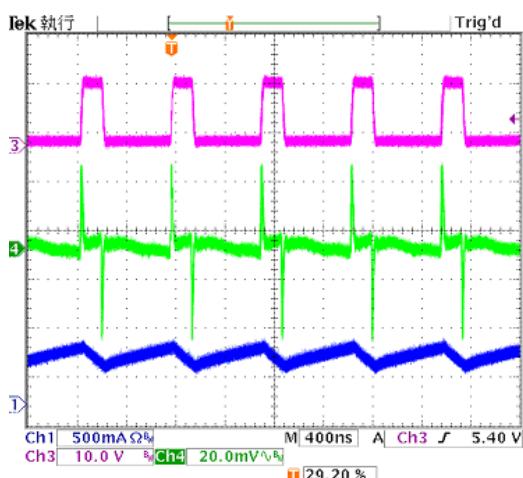
TYPICAL CHARACTERISTICS (Cont.)

Application Circuit


Ch1=Inductor Current
 Ch4=Output AC-Coupled
 Vcc=3.3V, Vout=12V
 Freq=640KHz
 $I_{LOAD}=10\text{mA} \sim 200\text{mA}$

LOAD-TRANSIENT RESPONSE


Ch1=Inductor Current
 Ch3=EN
 CH4=Vout
 Vcc=3.3V, Vout=12V
 $I_{LOAD}=10\text{mA}$
 Freq=640KHz

START UP WAVEFORM WITH SOFT-START

TYPICAL CHARACTERISTICS (Cont.)

START UP WAVEFORM WITH SOFT-START

SWITCHING WAVEFORM

DETAILED DESCRIPTION

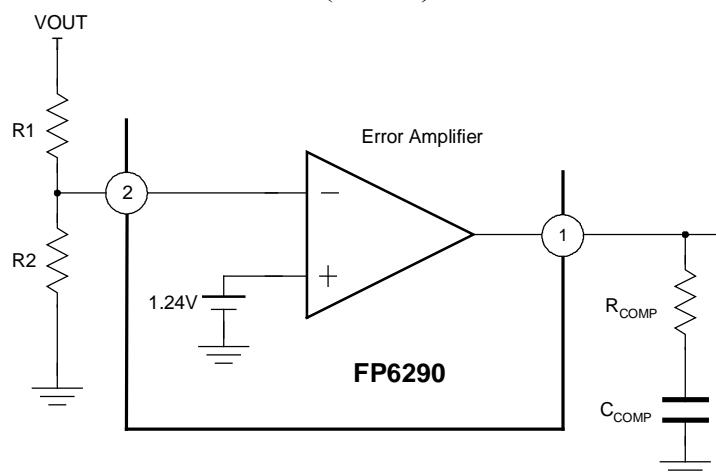
Voltage reference

A 1.24V reference regulator supplies **FP6290** internal circuits on the non-inverting terminal of error amplifier.

Error amplifier

The error amplifier compares a sample of the dc-dc converter output voltage to the 1.24V(Vref) reference and generates an error signal for the PWM comparator. Output voltage of dc-dc converter is setting with the resistor divider using the following expression :

$$V_{out} = \left(1 + \frac{R1}{R2}\right) * 1.24$$



Oscillator

The switching frequency of **FP6290** can be selected to operate at either 640KHz or 1.2MHz. When the FREQ pin is connected to GND for 640KHz operation, and connected to VCC for 1.2MHz operation. FREQ has an internal pull-down current about $5\mu A$, allowing the user the option of leaving FREQ unconnected for 640KHz operation.

Soft Start

The soft start is functional after power on, and the interval of soft start time is determined by a capacitor connected to SS pin (pin 2). When EN pin is taken high, the soft start capacitor (C_{SS}) is charged at a constant current of $4\mu A$ (typ). During this time, the SS voltage directly controls the peak inductor current. The maximum load current is available after the soft-start cycle is completed. When the EN pin is taken low, the soft-start capacitor is discharged to ground for next start up.

The load must wait for the soft-start cycle to finish before drawing a significant amount of load current. The duration after which the load can begin to draw maximum load current is:

$$T_{MAX} = 6.77 * 10^5 C_{SS}$$

EN

The **FP6290** is turn off to reduce the supply current to $0.1 \mu A$ when EN is low. In this mode, the internal reference, error amplifier, comparators, and biasing circuitry turn off while the N-channel MOSFET is turned off. The boost converter's output is connected to VCC by the external inductor and catch diode.

Output Current Capability

The output current capability of the **FP6290** is a function of current limit, input voltage, operation frequency, and inductor value. Because of the slope compensation used to stabilize the feedback loop, the duty cycle affects the current limit. The output current capability is governed by the following equation:

$$I_{OUT(MAX)} = [I_{LIM} * (1.26 - 0.4 * Duty) - 0.5 * Duty * V_{IN} / (f_{osc} * L)] * h * V_{IN} / V_{OUT}$$

Where:

I_{LIM} =current limit specified at 65%

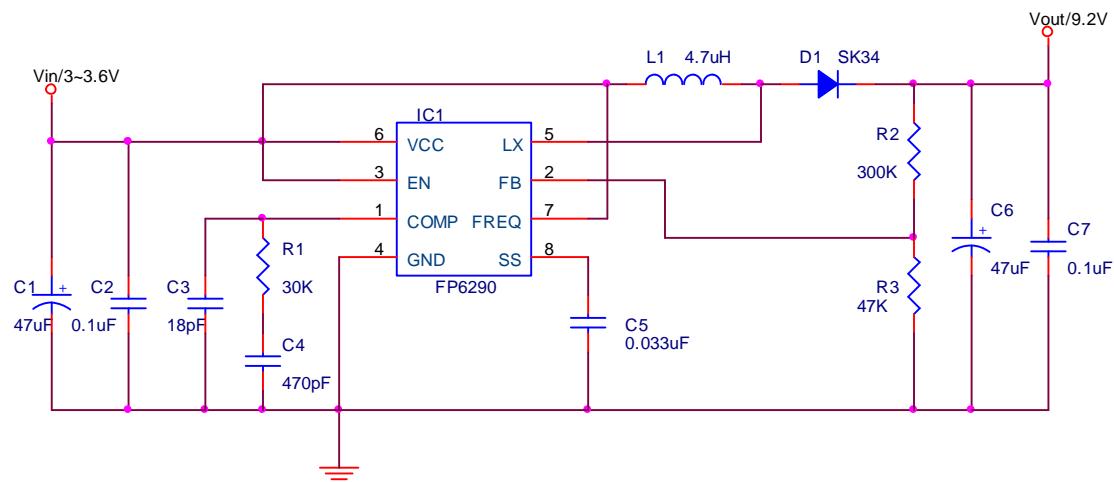
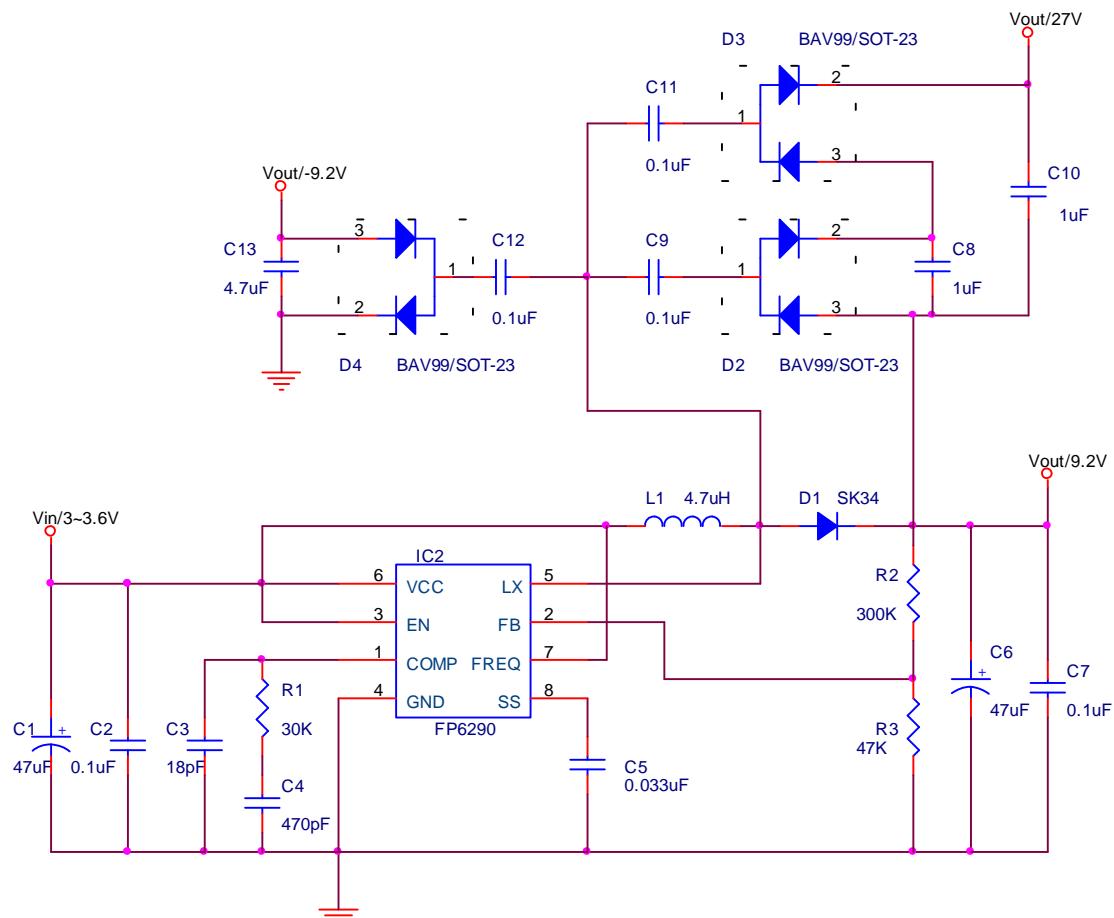
$$\text{Duty=duty cycle}=\frac{(V_{OUT}-V_{IN}+V_{DIODE})}{V_{OUT}-I_{LIM} * R_{ON}+V_{DIODE}}$$

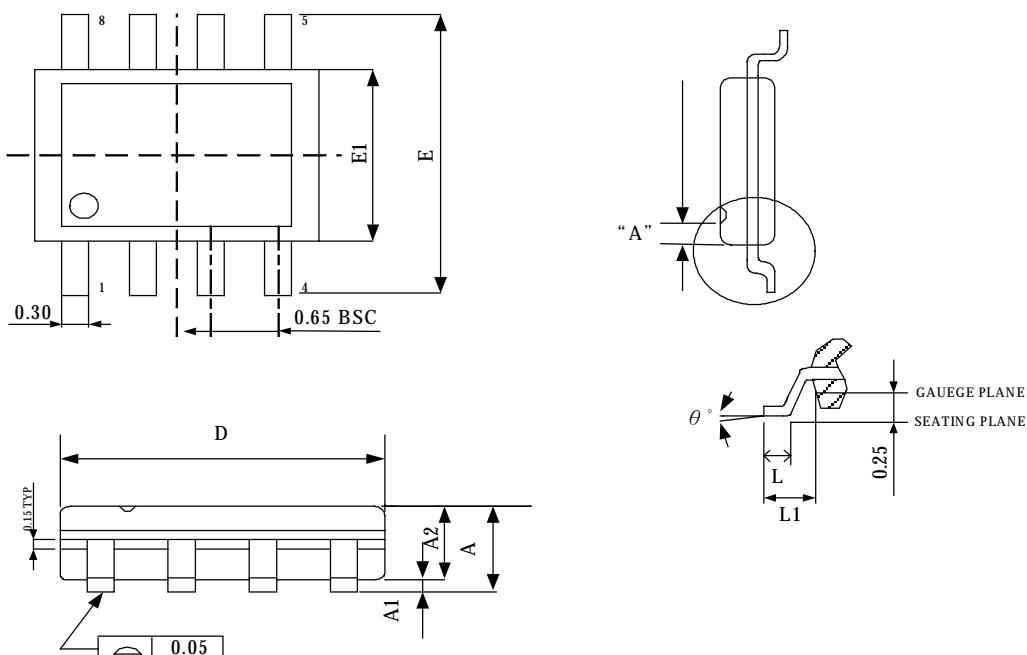
V_{DIODE} =catch diode forward voltage at ILIM

η =conversion efficiency,85%nominal

Current Limitation

The power-MOS switch current is monitored cycle-by-cycle and is limited to the value not exceed 1.6A (typ). When the switch current reaches the limited value, the power-MOS is turned off immediately until the next cycle.

APPLICATION NOTE

Figure 1 FP6290 Typical Application Circuits

Figure 2 FP6290 TFT Panel Power Supply Application Circuits

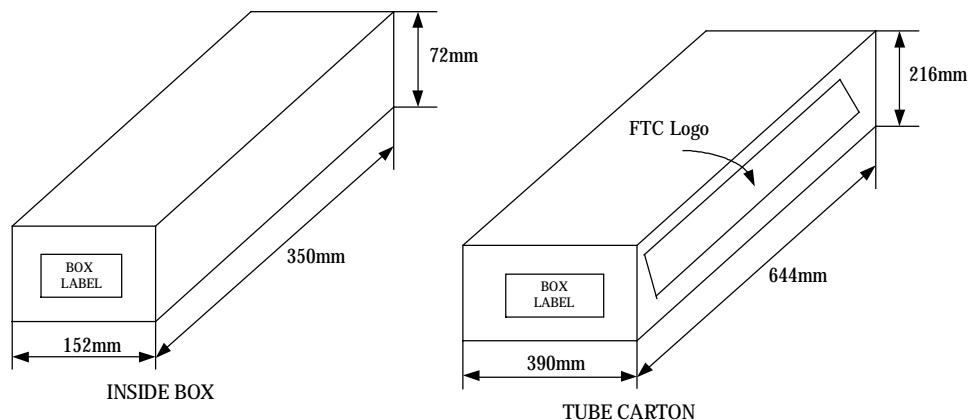
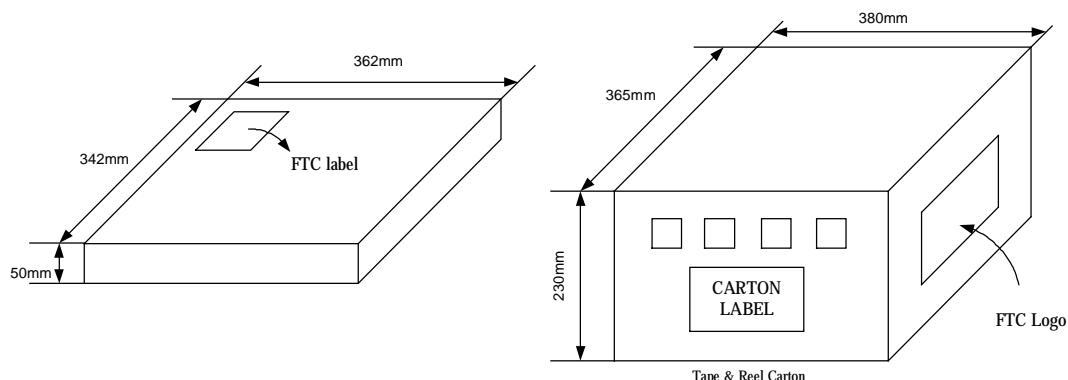
PACKAGE OUTLINE
MSOP-8L


SYMBOLS	MIN	MAX
A	-	1.10
A1	0.00	0.15
A2	0.75	0.95
D	3.00 BSC	
E	4.90 BSC	
E1	3.00 BSC	
L	0.40	0.80
L1	0.95 REF	
θ °	0	8

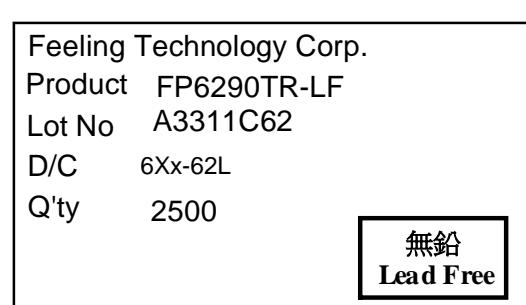
UNIT:MM

NOTE:

- 1.JEDEC OUTLINE:MO-187 AA
- 2.DIMENSIONS "D" DOES NOT INCLUDE MOLD FLASH,PROTRUSIONS OR GATE BURRS.MOLD FLASH,PROTRUSIONS AND GATE BURRS SHALL NOT EXCEED 0.15 PER SIDE
- 3.DIMENSIONS "E1" DOES NOT INCLUDE INTERLEAD FLASH,OR PROTRUSIONS. INTERLEAD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.25 PER SIDE.
- 4.DIMENSIONS "0.22" DOES NOT INCLUDE DAMBAR PROTRUSIONS.ALLOWABLE DAMBAR PROTRUSIONS SHALL BE 0.08 MM TOTAL IN EXCESS OF THE '0.22' DIMENSION AT MAXIMUM MATERIAL CONDITION.DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OF THE FOOT.MINIMIM SPAC BETWEEN PROTRUSION AND ADJACENT LEAD IS 0.07MM.
- 5.DIMENSIONS "D" AND 'E1' TO BE DETERMINED AT DATUM PLANE H

PACKING SPECIFICATIONS
BOX DIMENSION
TUBE INSIDE BOX AND CARTON

TAPE AND REEL INSIDE BOX AND CARTON

PACKING QUANTITY SPECIFICATIONS

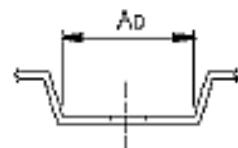
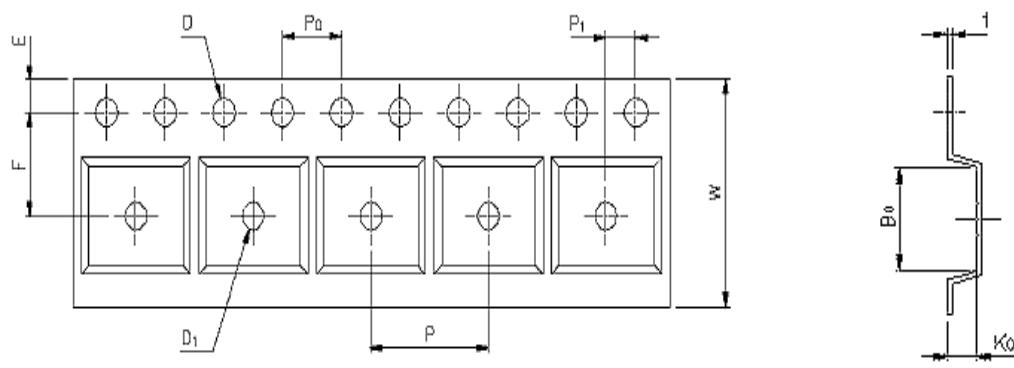
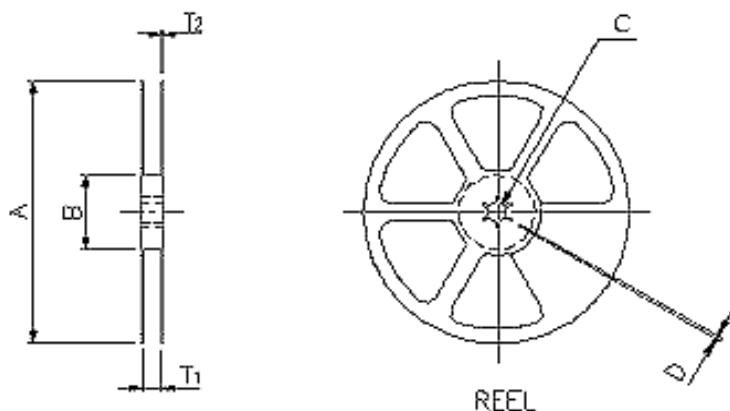
80 EA/TUBE	2500 EA / REEL
200 TUBES / INSIDE BOX	4 INSIDE BOXES / CARTON
8 INSIDE BOXES / CARTON	

LABEL SPECIFICATIONS
TAPPING & REEL
CARTON


MSOP8
CARRIER TAPE DIMENSIONS

APPLICATION	W	P	E	F	D	D ₁
MSOP8	12.0±3	8.0	1.75±1.0	5.5±0.5	1.5 ^{+0.1}	1.50

APPLICATION	P ₀	P ₁	A _D	B ₀	K ₀	t
MSOP8	4.0±0.1	2.0±0.5	4.20	3.30	1.20	0.30±0.5


REEL DIMENISONS


APPLICATION	MATERIAL	A	B	C	D	T ₁	T ₂
MSOP8	PLASTIC REEL	330±1	62±1.5	12.75 ^{+0.15}	2±0.15	12.4 ^{+0.2}	16.8 ^{-0.4}